## DT05 Rec'd PCT/PTO 2 5 OCT 2004

#### **Application Data Sheet**

### **Application Information**

Application Type:: Regular

Subject Matter:: Utility

Suggested Group Art Unit:: N/A

CD-ROM or CD-R?:: None

Sequence submission?:: None

Computer Readable Form (CRF)?:: No

Title:: HIGH-RESISTANCE SILICON WAFER

AND ITS MANUFACTURING METHOD

Attorney Docket Number:: 474082002800

Request for Early Publication?:: No

Request for Non-Publication?:: No

Total Drawing Sheets:: 6

Small Entity?:: No

Petition included?:: No

Secrecy Order in Parent Appl.?:: No

#### **Applicant Information**

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Nobumitsu

Family Name:: TAKASE

City of Residence: Tokyo

Country of Residence: Japan

Street of mailing address: c/o SUMITOMO MITSUBISHI SILICON

CORPORATION

2-1, Shibaura 1-chome, Minato-ku

Country of mailing address: Japan

105-0023 Postal or Zip Code of mailing address:

Inventor Applicant Authority Type::

Japan Primary Citzenship Country:

**Full Capacity** Status::

Hideshi Given Name::

**NISHIKAWA** Family Name::

Tokyo City of Residence:

Japan Country of Residence:

C/O SUMITOMO MITSUBISHI SILICON Street of mailing address:

CORPORATION

2-1, Shibaura 1-chome, Minato-ku

Japan Country of mailing address

105-0023 Postal or Zip Code of mailing address:

Japan Primary Citizenship Country::

**Full Capacity** Status::

**MAKOTO** Given Name::

ITO Family Name::

Tokyo City of Residence:

Japan Country of Residence:

C/O SUMITOMO MITSUBISHI SILICON Street of mailing address:

CORPORATION

2-1, Shibaura 1-chome, Minato-ku

Japan Country of mailing address

105-0023 Postal or Zip Code of mailing address:

Inventor Applicant Authority Type:

**Full Capacity** Status::

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Given Name:: Kouji

Family Name:: SUEOKA

City of Residence: Tokyo

Country of Residence: Japan

Street of mailing address: c/o SUMITOMO MITSUBISHI SILICON

**CORPORATION** 

2-1, Shibaura 1-chome, Minato-ku

Country of mailing address Japan

Postal or Zip Code of mailing address: 105-0023

Applicant Authority Type: Inventor

Status:: Full Capacity

Given Name:: Shinsuke

Family Name:: SADAMITSU

City of Residence: Tokyo

Country of Residence: Japan

Street of mailing address: c/o SUMITOMO MITSUBISHI SILICON

CORPORATION

2-1, Shibaura 1-chome, Minato-ku

Country of mailing address Japan

Postal or Zip Code of mailing address: 105-0023

**Correspondence Information** 

Correspondence Customer Number:: 25227

Representative Information

Representative Customer Number:: 25227

# **Foreign Priority Information**

| Country:: | Application number:: | Filing Date::     | Priority<br>Claimed:: |
|-----------|----------------------|-------------------|-----------------------|
| Japan     | 2002-127509          | April 26, 2002    | Yes                   |
| Japan     | 2002-360731          | December 12, 2002 | Yes                   |

**Assignee Information** 

Assignee Name::

SUMITOMO MITSUBISHI SILICON

CORPORATION

Street of mailing address::

2-1, Shibaura 1-chome

City of mailing address::

Minato-ku, Tokyo

Country of mailing address::

Japan

Postal or Zip Code of mailing address:: 105-0023